D2TO20

# Surface Mount Power Resistor Thick Film Technology 



## LINKS TO ADDITIONAL RESOURCES



## FEATURES

- AEC-Q200 qualified
- 20 W at $25^{\circ} \mathrm{C}$ case temperature
- Surface mounted resistor - TO-263 (D2PAK) style package
- Wide resistance range from $0.01 \Omega$ to $550 \mathrm{k} \Omega$
- Non inductive
- Resistor isolated from metal tab
- Solder reflow secure at $270{ }^{\circ} \mathrm{C} / 10 \mathrm{~s}$
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


Notes

- For the assembly on board, we recommend the lead (Pb)-free thermal profile as per J-STD-020C
- Power dissipation is 3.1 W at an ambient temperature of $25^{\circ} \mathrm{C}$ when mounted on a double sided copper board using FR4 HTG, $70 \mu \mathrm{~m}$ of copper, $39 \mathrm{~mm} \times 30 \mathrm{~mm} \times 1.6 \mathrm{~mm}$, with thermal vias

| STANDARD ELECTRICAL SPECIFICATIONS |  |  |  |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| MODEL | SIZE | RESISTANCE <br> RANGE <br> $\Omega$ | RATED POWER <br> $\boldsymbol{P}_{25}{ }^{\circ} \mathrm{C}$ <br> $\mathbf{W}$ | LIMITING ELEMENT <br> VOLTAGE $\boldsymbol{U}_{\mathrm{L}}$ <br> $\mathbf{V}$ | TOLERANCE <br> $\pm \%$ | TEMPERATURE <br> COEFFICIENT <br> $\pm \mathbf{p p m} /{ }^{\circ} \mathbf{C}$ | CRITICAL <br> RESISTANCE <br> $\Omega$ |
| D2TO20 | TO- 263 | 0.01 to 550 K | 20 | 500 | $1,2,5,10$ | $150,250,700,1100$ | 12.5 K |


| MECHANICAL SPECIFICATIONS |  |
| :--- | :---: |
| Mechanical Protection | Molded |
| Resistive Element | Thick film |
| Substrate | Alumina |
| Connections | Tinned copper |
| Weight | 2.2 g max. |


| ENVIRONMENTAL SPECIFICATIONS |  |
| :--- | :---: |
| Temperature Range | $-55^{\circ} \mathrm{C}$ to $+155^{\circ} \mathrm{C}$ |
| Flammability | IEC $60695-11-5$ <br> Application time: $\mathrm{t}_{\mathrm{t}}=10 \mathrm{~s}$ <br> Burning duration: $\mathrm{t}_{\mathrm{b}}<30 \mathrm{~s}$ |

## TECHNICAL SPECIFICATIONS

| Power Rating and <br> Thermal Resistance <br> of the Component | 20 W at $25^{\circ} \mathrm{C}$ (case <br> temperature) <br> $\mathrm{R}_{\text {TH }(\mathrm{j}-\mathrm{c})}: 6.5^{\circ} \mathrm{C} / \mathrm{W}$ |
| :--- | :---: |
| Temperature Coefficient <br> Standard | See Special Feature table <br> $\pm 150 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| Dielectric Strength <br> IEC 60115-1 | $2000 \mathrm{~V}_{\text {RMS }}-1$ min -10 mA max. <br> (between terminals and board) |
| Insulation Resistance | $\geq 10^{4} \mathrm{M} \Omega$ |
| Inductance | $\leq 0.1 \mu \mathrm{H}$ |


| DIMENSIONS |  |
| :--- | :---: |
| Standard Package | TO-263 style <br> (D2PAK) |

D2TO20

| SPECIAL FEATURES |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Resistance Values | $\geq 0.010$ | $\geq 0.045$ | $\geq 0.1$ | $\geq 0.5$ |
| Tolerances | $\pm 1 \%$ at $\pm 10 \%$ |  |  |  |
| $\begin{aligned} & \text { Requirement Temperature Coefficient (TCR) } \\ & \left(-55^{\circ} \mathrm{C}+150^{\circ} \mathrm{C}\right) \\ & \text { IEC } 60115-1 \end{aligned}$ | $\pm 1100 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | $\pm 700 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | $\pm 250 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | $\pm 150 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |


| PERFORMANCE |  |  |
| :---: | :---: | :---: |
| TESTS | CONDITIONS | REQUIREMENTS |
| Momentary Overload | $\begin{gathered} \text { IEC } 60115-1 \S 4.13 \\ 2 \operatorname{Pr} 5 \mathrm{~s} \text { for } R<2 \Omega \\ 1.5 \operatorname{Pr} 5 \mathrm{~s} \text { for } R \geq 2 \Omega \\ \text { US }<1.5 \mathrm{UL} \end{gathered}$ | $\pm(0.25 \%+0.005 \Omega)$ |
| Load Life | $\begin{gathered} \text { IEC } 60115-1 \\ 1000 \mathrm{~h}, 90 / 30 \mathrm{Pr} \text { at }+25^{\circ} \mathrm{C} \end{gathered}$ | $\pm(0.5 \%+0.005 \Omega)$ |
| High Temperature Exposure | AEC-Q200 rev. D conditions: MIL-STD-202 method 108 $1000 \mathrm{~h},+175^{\circ} \mathrm{C}$, unpowered | $\pm(0.25 \%+0.005 \Omega)$ |
| Temperature Cycling | Pre-conditioning 3 reflows according JESTD020D <br> IEC 60068-2-14 test Na <br> 1000 cycles, $-55^{\circ} \mathrm{C} /+175^{\circ} \mathrm{C}$ <br> Dwell time - 15 min | $\pm(0.5 \%+0.005 \Omega)$ |
| Moisture Resistance | AEC-Q200 rev. D conditions: MIL-STD-202 method 106 10 cycles, 24 h , unpowered | $\pm(0.5 \%+0.005 \Omega)$ |
| Biased Humidity | AEC-Q200 rev. D conditions: MIL-STD-202 method 103 $1000 \mathrm{~h}, 85^{\circ} \mathrm{C}, 85 \% \mathrm{RH}$ | $\pm(0.5 \%+0.005 \Omega)$ |
| Operational Life | AEC-Q200 rev. D conditions: Pre-conditioning 3 reflows according JESTD020D <br> MIL-STD-202 method 108 <br> $2000 \mathrm{~h}, 90 / 30$, powered, $+125^{\circ} \mathrm{C}$ | $\pm(0.5$ \% + $0.005 \Omega$ ) |
| ESD Human Body Model | $\begin{gathered} \text { AEC-Q200 rev. D conditions: } \\ \text { AEC-Q200-002 } \\ 25 \mathrm{kV}_{\text {AD }} \end{gathered}$ | $\pm(0.5 \%+0.005 \Omega)$ |
| Vibration | AEC-Q200 rev. D conditions: MIL-STD-202 method 204 5 g's for $20 \mathrm{~min}, 12$ cycles test from 10 Hz to 2000 Hz | $\pm(0.2 \%+0.005 \Omega)$ |
| Mechanical Shock | ```AEC-Q200 rev. D conditions: MIL-STD-202 method 213 100 g's, 6 ms, 3.75 m/s 3 shocks/direction``` | $\pm(0.2 \%+0.005 \Omega)$ |
| Board Flex | AEC-Q200 rev. D conditions: AEC-Q200-005 Bending $2 \mathrm{~mm} / 60 \mathrm{~s}$ | $\pm(0.25 \%+0.01 \Omega)$ |
| Terminal Strength | AEC-Q200 rev. D conditions: AEC-Q200-006 $1.8 \mathrm{kgf} / 60 \mathrm{~s}$ | $\pm(0.25 \%+0.01 \Omega)$ |

## ASSEMBLY SPECIFICATIONS

For the assembly on board, we recommend the lead (Pb)-free thermal profile as per J-STD-020C

| TESTS | CONDITIONS | REQUIREMENTS |
| :--- | :---: | :---: |
| Resistance to Soldering Heat | IEC $60115-1$ <br> IEC $60068-2-58$ <br> Solder bath method: $270^{\circ} \mathrm{C} / 10 \mathrm{~s}$ | $\pm(0.5 \%+0.005 \Omega)$ |
| Moisture Sensitivity Level (MSL) | IPC/JEDEC ${ }^{\circledR} \mathrm{J}-$ STD-020C <br> $85^{\circ} \mathrm{C} / 85 \% \mathrm{RH} / 168 \mathrm{~h}$ | Level: 1 <br> + pass requirements of TCR overload <br> and dielectric strength after MSL |

## CHOICE OF THE BOARD

The user must choose the board according to the working conditions of the component (power, room temperature). Maximum working temperature must not exceed $175^{\circ} \mathrm{C}$. The dissipated power is simply calculated by the following ratio:

$$
P=\frac{\Delta T}{R_{T H(j-c)}+R_{T H(c-h)}+R_{T H(h-a)}}
$$

P: expressed in W
$\Delta \mathrm{T}$ : difference between maximum working temperature and room temperature or fluid cooling temperature
$\mathrm{R}_{\mathrm{TH}(\mathrm{j}-\mathrm{c})}$ : thermal resistance value measured between resistive layer and outer side of the resistor. It is the thermal resistance of the component: $6.5^{\circ} \mathrm{C} / \mathrm{W}$.
$\mathrm{R}_{\mathrm{TH}(\mathrm{c}-\mathrm{h})}$ : thermal resistance value measured between outer side of the resistor and upper side of the board. This is the thermal resistance of the solder layer.
$\mathrm{R}_{T H(h-a)}$ : thermal resistance of the board.

## Example:

$\mathrm{R}_{\text {TH }(\mathrm{c}-\mathrm{h})}+\mathrm{R}_{\text {TH }(\mathrm{h}-\mathrm{a})}$ for D2TO20 power rating 2.5 W at ambient temperature $+25^{\circ} \mathrm{C}$.
Thermal resistance $\mathrm{R}_{\mathrm{TH}(\mathrm{j}-\mathrm{c})}: 6.5^{\circ} \mathrm{C} / \mathrm{W}$
Considering equation ${ }^{(1)}$ we have:

$$
\begin{aligned}
& \Delta \mathrm{T}=155^{\circ} \mathrm{C}-25^{\circ} \mathrm{C}=130^{\circ} \mathrm{C} \\
& \mathrm{R}_{T H}(\mathrm{j}-\mathrm{c})+\mathrm{R}_{\text {TH }(\mathrm{c}-\mathrm{h})}+\mathrm{R}_{\text {TH }(\mathrm{h}-\mathrm{a})}=\Delta \mathrm{T} / \mathrm{P}=130 / 2.5=52^{\circ} \mathrm{C} / \mathrm{W} \\
& \mathrm{R}_{\text {TH }(\mathrm{c}-\mathrm{h})}+\mathrm{R}_{\text {TH }(\mathrm{h}-\mathrm{a})}=52^{\circ} \mathrm{C} / \mathrm{W}-6.5^{\circ} \mathrm{C} / \mathrm{W}=45.5^{\circ} \mathrm{C} / \mathrm{W}
\end{aligned}
$$

## Single Pulse:

These informations are for a single pulse on a cold resistor at $25^{\circ} \mathrm{C}$ (not already used for a dissipation) and for pulses of 100 ms maximum duration.

The formula used to calculate $E$ is:

$$
E=P \times t=\frac{U^{2}}{R} \times t
$$

with:
$E(J)$ : pulse energy
$P(\mathrm{~W})$ : pulse power
$t(\mathrm{~s})$ : pulse duration
$U(\mathrm{~V})$ : pulse voltage
$R(\Omega)$ : resistor
The energy calculated must be less than that allowed by the graph.

## POWER RATING

The temperature of the case should be maintained within the limits specified.


## OVERLOADS

In any case the applied voltage must be lower than the maximum overload voltage of 750 V . The values indicated on the graph below are applicable to resistors in air or mounted onto a board.

## ENERGY CURVE



## POWER CURVE



D2TO20
Vishay Sfernice
IMPEDANCE CURVE $10 \Omega$ to $1 \mathrm{k} \Omega$ from 100 kHz to 300 MHz


## PACKAGING

- Reel
- Tube
- Tape dimensions (mm) for reel:



## MARKING

Model, style, resistance value (in $\Omega$ ), tolerance (in \%), manufacturing date, Vishay Sfernice trademark

| ORDERING INFORMATION |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| D2TO | 020 | c | $100 \mathrm{~K} \Omega$ | $\pm 1$ \% | xxx | e3 |
| MODEL | STYLE | CONNECTIONS | RESISTANCE | TOLERANCE | CUSTOM DESIGN | LEAD (Pb)-FREE |
|  |  |  |  | $\begin{gathered} F= \pm 1 \% \\ G= \pm 2 \% \\ J= \pm 5 \% \\ K= \pm 10 \% \end{gathered}$ | Optional on request: shape, etc. |  |

## SAP PART NUMBERING GUIDELINES



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